

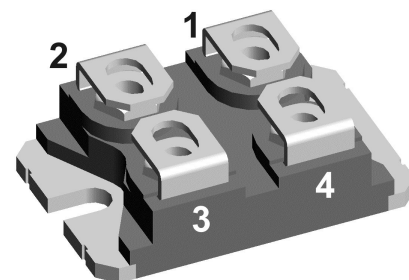
# Standard Rectifier

1~ Rectifier	
$V_{RRM}$	= 800 V
$I_{DAV}$	= 40 A
$I_{FSM}$	= 320 A

## 1~ Rectifier Bridge

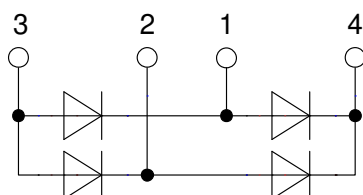
Part number

**VBO40-08NO6**



Backside: isolated

 E72873



### Features / Advantages:

- Planar passivated chips
- Very low leakage current
- Very low forward voltage drop
- Improved thermal behaviour

### Applications:

- Diode for main rectification
- For one phase bridge configurations
- Supplies for DC power equipment
- Input rectifiers for PWM inverter
- Battery DC power supplies
- Field supply for DC motors

### Package: SOT-227B (minibloc)

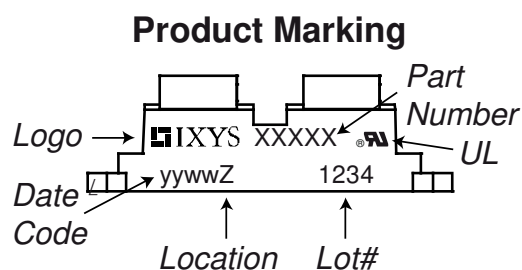
- Isolation Voltage: 3000 V~
- Industry standard outline
- RoHS compliant
- Epoxy meets UL 94V-0
- Base plate: Copper internally DCB isolated
- Advanced power cycling

### Disclaimer Notice

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Rectifier				Ratings			
Symbol	Definition	Conditions		min.	typ.	max.	Unit
$V_{RSM}$	max. non-repetitive reverse blocking voltage	$T_{VJ} = 25^{\circ}\text{C}$				900	V
$V_{RRM}$	max. repetitive reverse blocking voltage	$T_{VJ} = 25^{\circ}\text{C}$				800	V
$I_R$	reverse current	$V_R = 800\text{ V}$	$T_{VJ} = 25^{\circ}\text{C}$			40	$\mu\text{A}$
		$V_R = 800\text{ V}$	$T_{VJ} = 150^{\circ}\text{C}$			1.5	mA
$V_F$	forward voltage drop	$I_F = 20\text{ A}$	$T_{VJ} = 25^{\circ}\text{C}$			1.15	V
		$I_F = 40\text{ A}$				1.33	V
		$I_F = 20\text{ A}$	$T_{VJ} = 125^{\circ}\text{C}$			1.07	V
		$I_F = 40\text{ A}$				1.31	V
$I_{DAV}$	bridge output current	$T_C = 115^{\circ}\text{C}$ rectangular	$T_{VJ} = 150^{\circ}\text{C}$ $d = 0.5$			40	A
$V_{F0}$	threshold voltage	} for power loss calculation only		$T_{VJ} = 150^{\circ}\text{C}$		0.81	V
$r_F$	slope resistance					12.1	m $\Omega$
$R_{thJC}$	thermal resistance junction to case					1.3	K/W
$R_{thCH}$	thermal resistance case to heatsink				0.1		K/W
$P_{tot}$	total power dissipation	$T_C = 25^{\circ}\text{C}$				95	W
$I_{FSM}$	max. forward surge current	$t = 10\text{ ms}; (50\text{ Hz}), \text{ sine}$	$T_{VJ} = 45^{\circ}\text{C}$			320	A
		$t = 8,3\text{ ms}; (60\text{ Hz}), \text{ sine}$	$V_R = 0\text{ V}$			345	A
		$t = 10\text{ ms}; (50\text{ Hz}), \text{ sine}$	$T_{VJ} = 150^{\circ}\text{C}$			270	A
		$t = 8,3\text{ ms}; (60\text{ Hz}), \text{ sine}$	$V_R = 0\text{ V}$			295	A
$I^2t$	value for fusing	$t = 10\text{ ms}; (50\text{ Hz}), \text{ sine}$	$T_{VJ} = 45^{\circ}\text{C}$			510	A <sup>2</sup> s
		$t = 8,3\text{ ms}; (60\text{ Hz}), \text{ sine}$	$V_R = 0\text{ V}$			495	A <sup>2</sup> s
		$t = 10\text{ ms}; (50\text{ Hz}), \text{ sine}$	$T_{VJ} = 150^{\circ}\text{C}$			365	A <sup>2</sup> s
		$t = 8,3\text{ ms}; (60\text{ Hz}), \text{ sine}$	$V_R = 0\text{ V}$			360	A <sup>2</sup> s
$C_J$	junction capacitance	$V_R = 400\text{ V}; f = 1\text{ MHz}$			11		pF

Package SOT-227B (minibloc)				Ratings				
Symbol	Definition	Conditions		min.	typ.	max.	Unit	
I <sub>RMS</sub>	RMS current	per terminal				150	A	
T <sub>VJ</sub>	virtual junction temperature			-40		150	°C	
T <sub>op</sub>	operation temperature			-40		125	°C	
T <sub>stg</sub>	storage temperature			-40		150	°C	
Weight					30		g	
M <sub>D</sub>	mounting torque			1.1		1.5	Nm	
M <sub>T</sub>	terminal torque			1.1		1.5	Nm	
d <sub>Spp/App</sub>	creepage distance on surface   striking distance through air	terminal to terminal	10.5	3.2			mm	
d <sub>Spb/Apb</sub>		terminal to backside	8.6	6.8			mm	
V <sub>ISOL</sub>	isolation voltage	t = 1 second	50/60 Hz, RMS; I <sub>ISOL</sub> ≤ 1 mA		3000			V
		t = 1 minute			2500			V



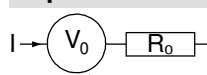
Ordering	Ordering Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	VBO40-08NO6	VBO40-08NO6	Tube	10	475866

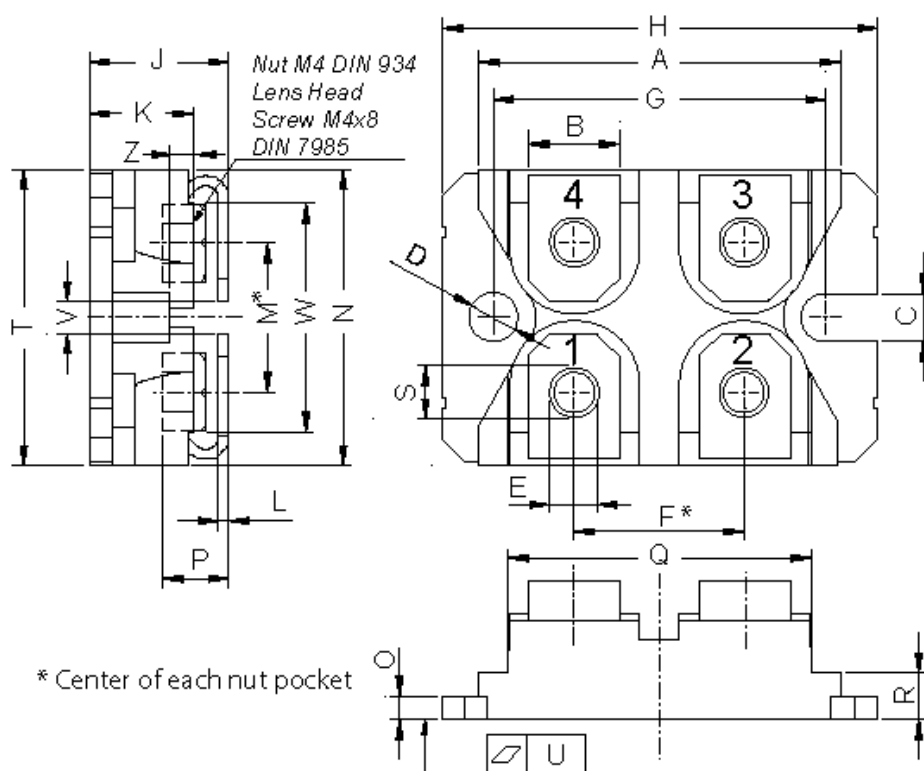
Similar Part	Package	Voltage class
VBO40-12NO6	SOT-227B (minibloc)	1200
VBO40-16NO6	SOT-227B (minibloc)	1600

### Equivalent Circuits for Simulation

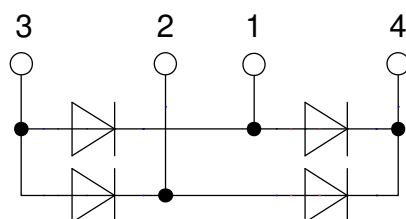
\* on die level

$T_{VJ} = 150^{\circ}\text{C}$

		<b>Rectifier</b>	
$V_{0\ max}$	threshold voltage	0.81	V
$R_{0\ max}$	slope resistance *	10.2	mΩ

**Outlines SOT-227B (minibloc)**


Dim.	Millimeter		Inches	
	min	max	min	max
A	31.50	31.88	1.240	1.255
B	7.80	8.20	0.307	0.323
C	4.09	4.29	0.161	0.169
D	4.09	4.29	0.161	0.169
E	4.09	4.29	0.161	0.169
F	14.91	15.11	0.587	0.595
G	30.12	30.30	1.186	1.193
H	37.80	38.23	1.488	1.505
J	11.68	12.22	0.460	0.481
K	8.92	9.60	0.351	0.378
L	0.74	0.84	0.029	0.033
M	12.50	13.10	0.492	0.516
N	25.15	25.42	0.990	1.001
O	1.95	2.13	0.077	0.084
P	4.95	6.20	0.195	0.244
Q	26.54	26.90	1.045	1.059
R	3.94	4.42	0.155	0.167
S	4.55	4.85	0.179	0.191
T	24.59	25.25	0.968	0.994
U	-0.05	0.10	-0.002	0.004
V	3.20	5.50	0.126	0.217
W	19.81	21.08	0.780	0.830
Z	2.50	2.70	0.098	0.106



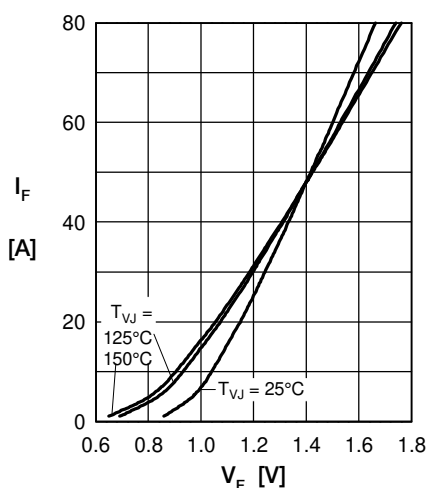
**Rectifier**


Fig. 1 Forward current vs. voltage drop per diode

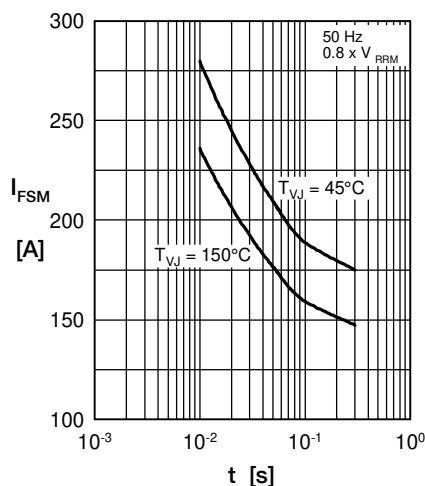


Fig. 2 Surge overload current vs. time per diode

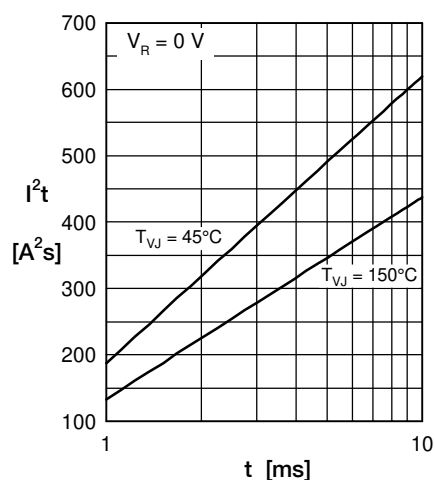


Fig. 3  $I^2t$  vs. time per diode

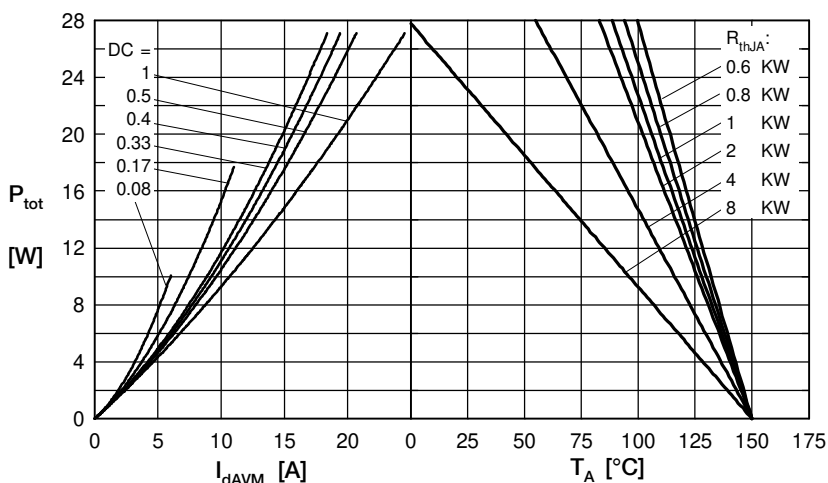


Fig. 4 Power dissipation vs. forward current and ambient temperature per diode

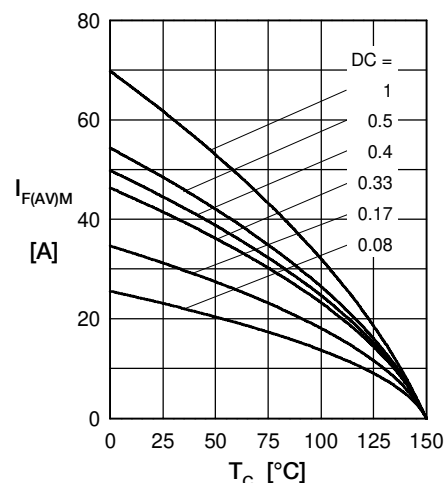


Fig. 5 Max. forward current vs. case temperature per diode

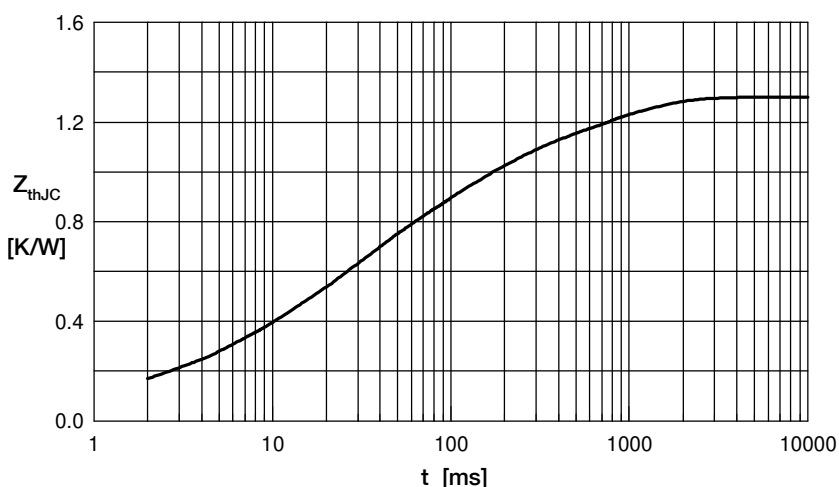


Fig. 6 Transient thermal impedance junction to case vs. time per diode

Constants for  $Z_{thJC}$  calculation:

i	$R_{th}$ (K/W)	$t_i$ (s)
1	0.061	0.0002
2	0.145	0.0036
3	0.398	0.0200
4	0.405	0.1000
5	0.291	0.7000